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User's Manual

μ SAP77016-B08

AAC Audio Decoder Middleware

Target Device

μ PD77110

μ PD77113A

μ PD77114

μ PD77115

μ PD77210

μ PD77213

[MEMO]

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Major Revisions in This Edition

Page	Description
p.13	Change of the product name μ PD77113 of 1.3.3 (1) Operable DSPs to μ PD77113A. Addition of the μ PD77210 and 77213.
p.13	Change of the size in Table1-3 Required Memory Sizes .
p.20	Modification of description of Arguments R0,R5 in 2.2.1 a2d_InitDec function
p.23	Modification of description of Arguments R0 and Hardware resourcement in 2.2.3 a2d_Dec function .
p.25	Modification of description of Return value R0 in 2.2.5 a2d_GetStatus function .
p.26	Modification of description of Function table in 2.2.6 a2d_GetErrorStatus function .
p.27	Modification of description of Argument, Return value and Registers used in 2.2.7 aac_dec_fillbits function .
p.28	Modification of description 2.2.8 aac_read_1word function .
p.38 to 45	Modification of description in APENDIX SAMPLE PROGRAM SOURCE <ul style="list-style-type: none"> • sample.asm a2d.h → a2d_dec.h, a2d_errh.h→a2d_err.h • sam_call.asm replaced • sam_deta.asm a2d.h → a2d_dec.h • sam_int.asm a2d.h → a2d_dec.h, a2d_errh.h→a2d_err.h

The mark ★ shows major revised points.

PREFACE

Target Readers This manual is for users who design and develop μ PD77016 Family application systems.

μ PD77016 Family is the generic name for the μ PD7701x family (μ PD77015, 77016, 77017, 77018A, 77019), the μ PD77111 Family (μ PD77110, 77111, 77112, 77113A, 77114, 77115) and the μ PD77210 Family (μ PD77210, 77213). However, this manual is for μ PD77110, 77113A, 77114, 77115, 77210 and 77213 devices.

Purpose The purpose of this manual is to help users understand the supporting middleware when designing and developing μ PD77016 Family application systems.

Organization This manual consists of the following contents.

CHAPTER 1 OVERVIEW
CHAPTER 2 LIBRARY SPECIFICATIONS
CHAPTER 3 INSTALLATION
CHAPTER 4 SYSTEM EXAMPLES
APPENDIX SAMPLE PROGRAM SOURCE

How to Read This Manual It is assumed that the reader of this manual has general knowledge in the fields of electrical engineering, logic circuits, microcontrollers, and the C language.

To learn about μ PD77111 Family hardware functions

→ Refer to **μ PD77111 Family User's Manual Architecture**.

To learn about μ PD77210 Family hardware functions

→ Refer to **μ PD77210 Family User's Manual Architecture**.

To learn about μ PD77016 Family hardware functions

→ Refer to **μ PD77016 Family User's Manual Instruction**.

Conventions	Data significance:	Higher digits on the left and lower digits on the right
	Active low representation:	\overline{XXX} (overscore over pin or signal name)
	Note:	Footnote for item marked with Note in the text
	Caution:	Information requiring particular attention
	Remark:	Supplementary information
	Numerical representation:	Binary ... XXXX or 0bXXXX
		Decimal ... XXXX
		Hexadecimal ... 0xXXXX

Related Documents

The related documents indicated in this publication may include preliminary versions. However, preliminary versions are not marked as such.

Documents Related to Devices

Document Name Name Part Number	Pamphlet	Data Sheet	User's Manual		Application Note
			Architecture	Instructions	Basic Software
μ PD77110	U12395E	U12801E	U14623E	U13116E	U11958E
μ PD77111					
μ PD77112					
μ PD77113					
μ PD77114		U14373E			
μ PD77115		U14867E			
μ PD77210		U15203E	U15807E		
μ PD77213					

Documents Related to Development Tools

Document Name		Document No.
RX77016 User's Manual	Function	U14397E
	Configuration Tool	U14404E
RX77016 Application Note	HOST API	U14371E

Caution The related documents listed above are subject to change without notice. Be sure to use the latest version of each document for designing.

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CHAPTER 1 OVERVIEW

1.1 Middleware

Middleware is the name given to a group of software that has been tuned so that it draws out the maximum performance of the processor and enables processing that is conventionally performed by hardware to be performed by software.

The concept of middleware was introduced with the development of a new high-speed processor, the DSP, in order to facilitate operation of the environments integrated in the system.

By providing appropriate speech codec and image data compression/decompression-type middleware, NEC is offering users the kind of technology essential in the realization of a multimedia system for the μ PD77016 Family, and is continuing its promotion of system development.

μ SAP77016-B08 is middleware that provides AAC-technology decoding functions.

1.2 AAC Audio Decoder

AAC is a form of audio coding for multiple channels (up to 64 channels) that achieves high quality and high compression rates by excluding compatibility with MPEG-1 audio. The relevant standard is ISO/IEC 13818-7.

In this user's manual, AAC is an abbreviation for Advanced Audio Coding.

μ SAP77016-B08 complies with this AAC-technology decoding method. The compressed data is data that encodes a digital signal converted to 16-bit linear PCM data after sampling an analog signal at frequencies shown in Table 1-1.

Note that μ SAP77016-B08 decodes and outputs at most two front channels.

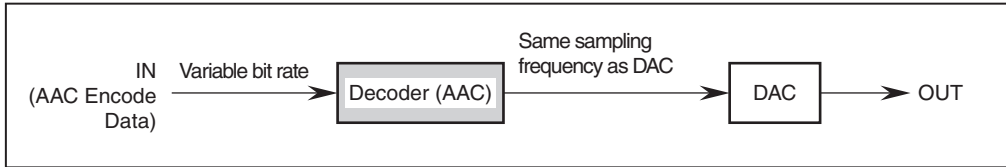
Table 1-1. Sampling Frequencies

Frequency [Hz]
8000
11025
12000
16000
22050
24000
32000
44100
48000
64000
88200
96000

1.2.1 Decoder outline

Figure 1-1 is a sample configuration of decoding using μ SAP77016-B08.

Figure 1-1. Sample Configuration of Decoding



(1) AAC Encode Data

AAC Encode Data is data in which sampled 16-bit linear PCM data is encoded. For sampling frequencies, refer to **Table 1-1 Sampling Frequencies**. The maximum value of the bit rate differs according to the sampling frequency. The bit rate can have any value up to the maximum value. Table 1-2 shows the maximum values of bit rate.

Table 1-2. Maximum Bit Rates

Sampling Frequency [Hz]	Maximum Bit Rate [kbps/ch]
8000	48
11025	66.15
12000	72
16000	96
22050	132.3
24000	144
32000	192
44100	264.6
48000	288
64000	384
88200	529.2
96000	576

(2) AAC decoder (Decoder(AAC))

The AAC decoder (Decoder(AAC)) reads input data, performs decoding, and outputs 16-bit linear PCM data. It decodes and outputs at most two front channels.

In ADTS format, it performs CRC processing as error compensation at the end.

(3) DAC

The DAC converts 16-bit linear PCM data to an analog signal.

The DAC must operate at the sampling frequency attached to the encoded data.

If the sampling frequency of the encoded data differs from the DAC, separate frequency conversion software (such as a rate converter) is needed.

1.3 Product Overview

1.3.1 Features

- Employs AAC decoder algorithm standardized by ISO/IEC
- Bit rates correspond to maximum bit rates shown in **Table 1-2 Maximum Bit Rates**
- Input data is encoded 16-bit linear PCM data sampled at a sampling frequency (**Table 1-1 Sampling Frequencies**)
- Output data is 16-bit linear PCM data of the same frequency as the sampling frequency of input data
- 1024 samples/frame/channel decoding
- Supports ADTS, ADIF, and RAW formats
- Provides CRC as error compensation (ADTS format only)
- Supports decoding of two front channels

1.3.2 Functions

(1) Decompression processing

Decompression processing converts compressed data to one RAW of 16-bit linear PCM data.

(2) Error compensation

CRC is performed as error compensation processing in ADTS format.

1.3.3 Operating environment

- ★ **(1) Operable DSPs:**
 μ PD77110, 77113A, 77114, 77115, 77210, 77213

- (2) Required memory size:**
 μ SAP77016-B0B requires memory sizes shown in the following table.

★ **Table 1-3. Required Memory Sizes**

Memory	Type		Size [kwords]
Instruction memory	-		8.6
X memory	RAM	Scratch area	2.0
		Static area	0.7
	ROM		4.0
Y memory	RAM	Scratch area	4.0
		Static area	4.1
	ROM		3.9

Caution One word of instruction memory is 32 bits.
 One word of X memory or Y memory is 16 bits.

Scratch areas are memory areas that can be discarded when μ SAP77016-B08 is not operating. The user should define scratch areas. A defined scratch area must be set using the a2d_InitDec function.

The user can use scratch areas when μ SAP77016-B08 is not operating. However, caution is required when using these areas. Since μ SAP77016-B08 will use these areas again when it operates, if a user has set information in scratch areas, the set information cannot be guaranteed.

Refer to Table 1-4 when using scratch areas.

Table 1-4. Scratch Areas

Memory	Public Symbol Name	Address	Size [words]
X memory	lib_Scratch_x	Specify at 0	2048
Y memory	lib_Scratch_y	Specify align at 0	4096

A static area is a memory area that cannot be discarded even when μ SAP77016-B08 is not operating. A user cannot use a static area.

Besides the memories described in Table 1-3, input buffer (X memory) and output buffer (X memory) are required.

In the sample program described later, 1024 words are used as an input buffer and 2048 words as two output buffers, for a total of three buffers.

(3) Required D/A specs

D/A 2 ch, 16-bit resolution, shown in **Table 1-1 Sampling Frequencies**

(4) Software tools (Windows™ version)

Table 1-5. Software Tools

Relevant DSP	Software Tools
μ PD77016 Family	DSP tools WB77016 (Workbench) HSM77016 (High-speed simulator)

1.3.4 Performance

Table 1-6 shows the MIPS values that are necessary in order to execute one frame processing in real time.

Measurement and Calculation Conditions DSP: μ PD77110 (operating frequency: 75 MHz, 75 MIPS)
Sampling frequency: 44.1 kHz

Table 1-6. MIPS Needed in One Frame Decompression Processing

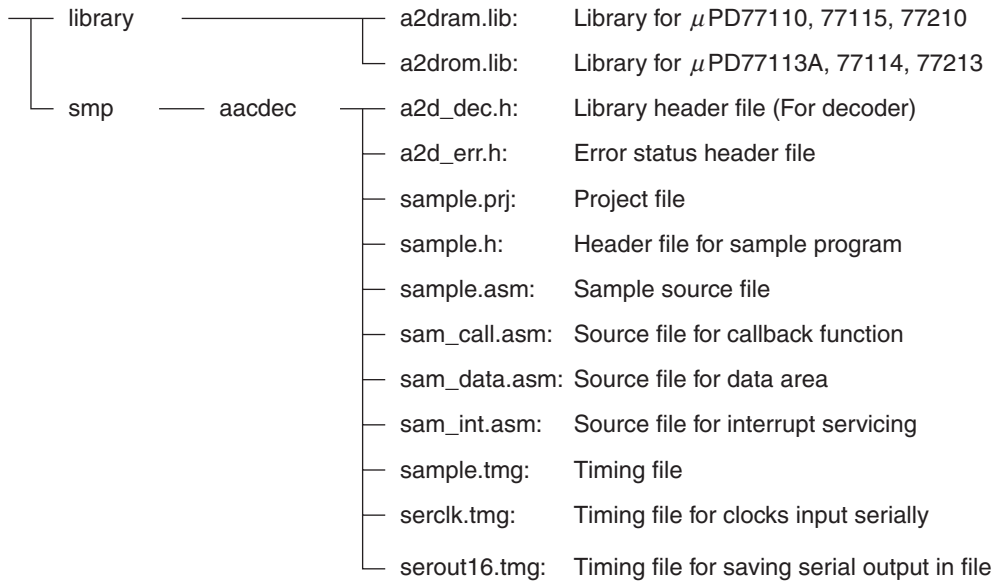
Measurement and Calculation Condition		Decompression Time [MIPS/ch]
Decompression	Logical maximum MIPS value ^{Note 1}	24.2
	Measured maximum MIPS value ^{Note 2}	13.5
	Measured average MIPS value ^{Note 2}	11.0
CRC (ADTS only)	Logical ^{Note 1} value	0.5

- Notes**
1. Logical means that the value is calculated by taking the maximum number of cycles for the number of loops, number of repeats, and algorithm processing route in a program.
 2. Measured means that the MIPS value was measured by actually executing μ SAP77016-B08 on a real machine and decompressing stereo (2-channel) encoded data at an average bit rate of 128 kbps.

1.3.5 Directory configuration

The directory configuration of μ SAP77016-B08 is shown below.

μ PD77016 Family



A summary of each directory is shown below.

(1) library

This directory contains library files.

(2) smp --- aacdec

This directory contains sample program source files and header files. It also provides timing files described later.

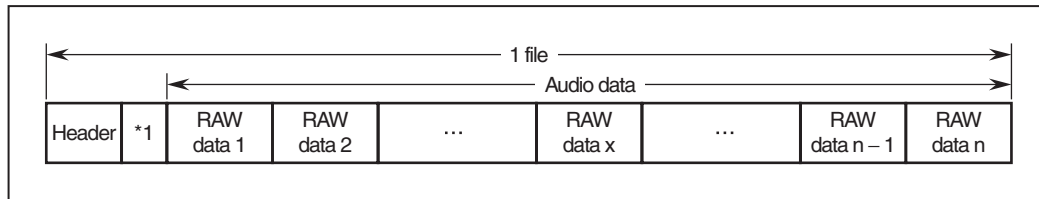
1.4 Compressed Data Format

For details of the compressed data format, refer to standards (ISO/IEC 13818-7).
 μSAP77016-B08 specifications conform to standards.

1.4.1 ADIF format outline

Figure 1-2 shows the structure of ADIF format.

Figure 1-2. ADIF Format

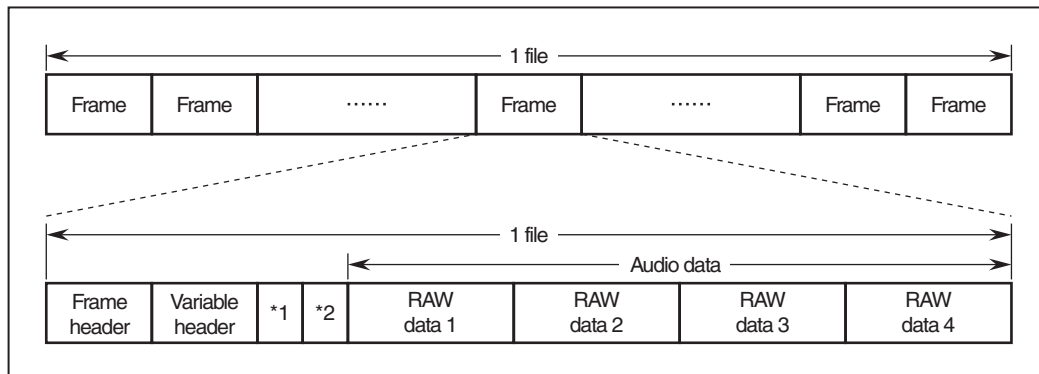


- Remark** Header: Contains information for synchronizing, such as sampling frequency, bit rate, and mode.
 Audio data: This is information related to the audio sample. It consists of multiple RAW data bit streams.
 RAW data: This is a bit stream of the smallest unit that is decoded.
 *1: Bit alignment

1.4.2 ADTS format outline

Figure 1-3 shows the structure of ADTS format.

Figure 1-3. ADTS Format

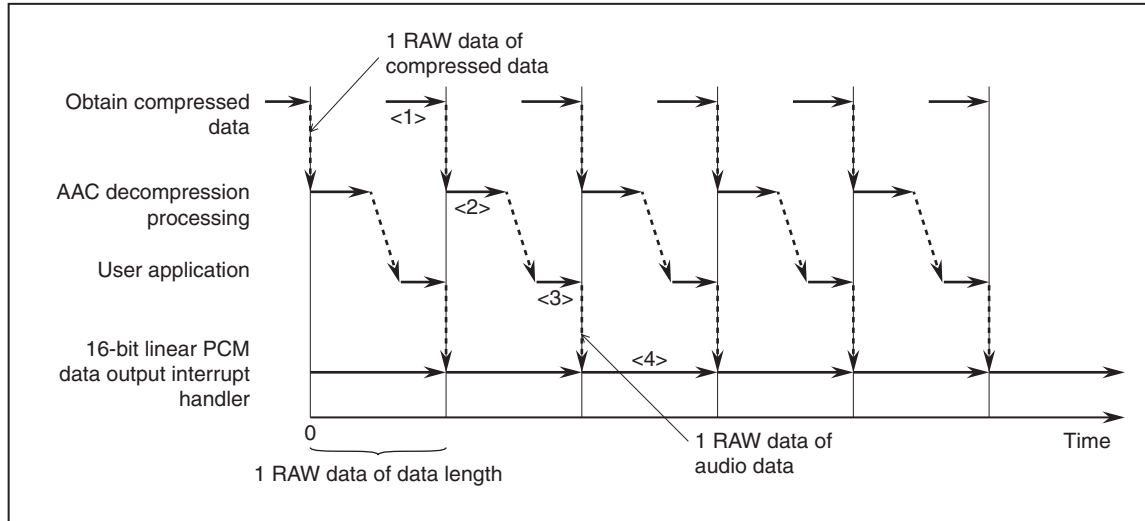


- Remark** Frame header: Contains information for synchronizing, such as sampling frequency, bit rate, and mode.
 Variable header: This is information needed in decoding, such as the number of RAW data bit streams included in the audio data.
 Audio data: This is information related to the audio sample. It consists of multiple RAW data bit streams.
 RAW data: This is a bit stream of the smallest unit that is decoded. There are up to four in one frame.
 *1: Error check
 *2: Bit alignment

1.5 Timing Diagram

Figure 1-4 shows the timing diagram of Decoder.

Figure 1-4. Timing Diagram



<1> Read 1 RAW data of compressed data and pass it to decompression processing.

<2> Convert 1 RAW data of compressed data to 1 RAW data of decompressed data.

<3> Buffer decompressed data. Besides this, perform application processing.

If the sampling frequency differs from that of DAC, the user should execute Rate Conversion to convert to the same sampling frequency as DAC.

<4> Perform D/A conversion of 1 RAW data of 16-bit linear PCM data.

CHAPTER 2 LIBRARY SPECIFICATIONS

2.1 Library Overview

μ SAP77016-B08 provides the following six functions.

Table 2-1. List of Library Functions

Function Name	Function
a2d_InitDec	Initialize decompression processing
a2d_set_adif_header	ADIF/RAW parameter initialization processing
a2d_Dec	Decompression processing
a2d_GetVersion	Obtain version information
a2d_GetStatus	Obtain status information
a2d_GetErrorStatus	Obtain error information

In addition, the functions in Table 2-2 must be defined to operate μ SAP77016-B08. These functions need to be provided by the user.

Table 2-2. User-Defined Functions

Function Name	Function
aac_read_1word	Read frame header
aac_dec_fillbits	Obtain input data

2.2 Function Specifications

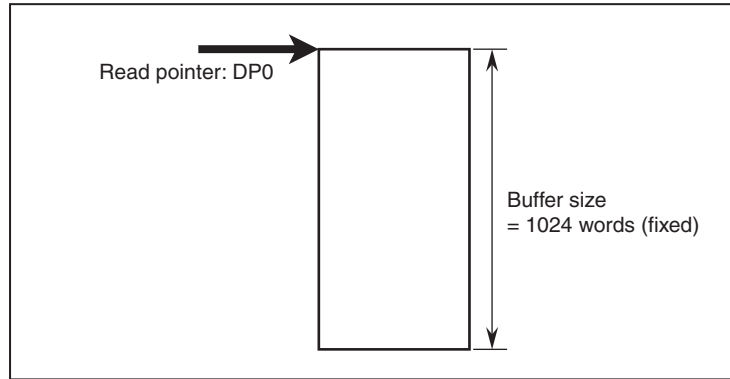
Specifications when calling each library function are shown below.

2.2.1 a2d_InitDec function

[Classification]	AAC decoder initialization processing
[Function name]	a2d_InitDec
[Summary of function]	Initializes RAM areas and sets parameters used by μ SAP77016-B08
[Format]	call a2d_InitDec
[Arguments]	R0 Initialization mode
	Bit 0 0: Decode RAW_DATA only
	1: Decode format with header (ADIF/ADTS)
★	Bit 8 0: Normal
	1: Check header using aac_read_1word function on CRC error when ADTS decoding
	R1 Reserved
	R2 Reserved
	R3 Reserved
	R4 Address of callback function aac_read_1word
★	R5 Address of callback function aac_dec_fillbits
	R6 0x0000 fixed (Address of scratch area lib_Scratch_x)
	R7 Address of scratch area lib_Scratch_y
	DP0 Pointer to user-defined input buffer (see Figure 2-1)
[Return value]	R0 0: Decoding error
	1: Decoded object was ADIF/RAW
	2: Decoded object was ADTS
[Function]	Initialize RAM areas used by μ SAP77016-B08 and set parameters.
[Registers used]	R0, R1, R2, R3, R4, R5, R6, R7, DP0, DP4
[Hardware resourcement]	
	Maximum stack level 3
	Maximum loop stack level 2
	Maximum number of repeats 1023
	Maximum number of cycles 48413

Caution The a2d_InitDec function initializes only RAM areas that the μ SAP77016-B08 uses. Initialization of user-defined RAM areas (such as I/O buffers) should be performed in a user program.

Figure 2-1. User-Defined Input Buffer



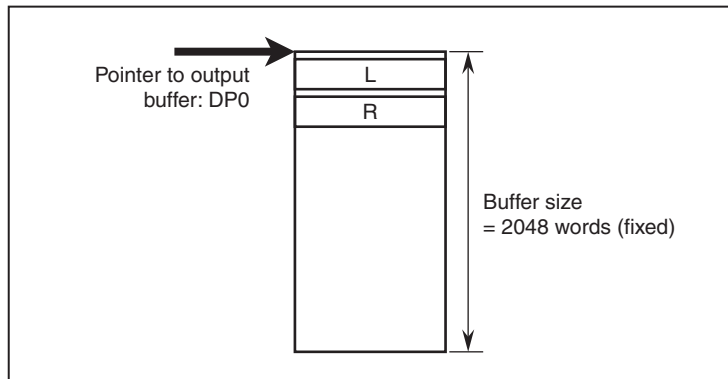
2.2.2 a2d_set_adif_header function

[Classification]	ADIF/RAW parameter initialization processing
[Function name]	a2d_set_adif_header
[Summary of function]	Sets parameters required for ADIF/RAW format decoding
[Format]	call a2d_set_adif_header
[Arguments]	DP0 Pointer to parameter save area
[Return value]	R0 0: Error Other than 0: Normal
[Function]	Set parameters required for ADIF/RAW format decoding.
[Registers used]	R0, R2, R4, R5, R6, DP0, DP1, DP2
[Hardware resourcement]	
	Maximum stack level 1
	Maximum loop stack level 1
	Maximum number of repeats 0
	Maximum number of cycles 128

2.2.3 a2d_Dec function

[Classification]	AAC decoder processing	
[Function name]	a2d_Dec	
[Summary of function]	Executes AAC decoding and obtains result of decoding	
[Format]	call a2d_Dec	
★ [Arguments]	R0	0: Decode RAW_DATA only 1: Decode ADIF 2: Decode ADTS
	R1	0: Perform normal decoding 1: Skip decoding for one frame
	DP0	Pointer to PCM data output area (see Figure 2-2)
[Return value]	R0	0: Error Other than 0: Normal
[Function]	Perform decoding in the mode specified in R0 and obtain a 2048-word decoding result. Output the decoding result in the output buffer specified in DP0.	
[Registers used]	R0, R1, R2, R3, R4, R5, R6, R7, DP0, DP1, DP2, DP3, DP4, DP5, DP6, DP7, DN0, DN1, DN2, DN3, DN4, DN5, DN6, DN7, DMX, DMY	
★ [Hardware resourcement]	Maximum stack level	6
	Maximum loop stack level	4
	Maximum number of repeats	176 (Measured maximum value)
	Maximum MIPS value	31 MIPS (If there is no error encoding) 31.5 MIPS (If there is error encoding)

Figure 2-2. User-Defined Output Buffer



2.2.4 a2d_GetVersion function

[Classification]	Version information acquisition
[Function name]	a2d_GetVersion
[Summary of function]	Returns the version of the library.
[Format]	call a2d_GetVersion
[Arguments]	None
[Return value]	R0H Major version number R0L Minor version number
[Function]	Return the version number of the μ SAP77016-B08 library in a 32-bit value. Version when R0 = 0x00'0x0001'0x0100: V1.01
[Registers used]	R0
[Hardware resourcement]	
	Maximum stack level 0
	Maximum loop stack level 0
	Maximum number of repeats 0
	Maximum number of cycles 6

2.2.5 a2d_GetStatus function

[Classification] Status information acquisition

[Function name] a2d_GetStatus

[Summary of function] Obtains the status of the decoding result.
Information from the decoding performed just before this function was called is returned as the status.

[Format] call a2d_GetStatus

[Arguments] None

[Return value]

R0 0: Decode error
 1: ADIF/RAW format
 2: ADTS format

R1 0: Result of decoding is monaural
 1: Result of decoding is stereo

R2 Index value of sampling frequency (See **Table 2-3**)

R3 0: Normal decoding
 Other than 0: Skip 1 frame of decoding

R4 Indicates the size [byte] of input data that is decoded by a2d_Dec just before this function

[Function] Obtain status information and set registers.

[Registers used] R0, R1, R2, R3, R4

[Hardware resourcement]

Maximum stack level 0

Maximum loop stack level 0

Maximum number of repeats 0

Maximum number of cycles 15



Table 2-3. Values of a2d_GetStatus() Return Value R2

Value of R2 (index value)		Sampling Frequency [Hz]
hex	bin	
0x00	'0000'	96000
0x01	'0001'	88200
0x02	'0010'	64000
0x03	'0011'	48000
0x04	'0100'	44100
0x05	'0101'	32000
0x06	'0110'	24000
0x07	'0111'	22050
0x08	'1000'	16000
0x09	'1001'	12000
0x0a	'1010'	11025
0x0b	'1011'	8000

2.2.6 a2d_GetErrorStatus function

[Classification] Error information acquisition
 [Function name] a2d_GetErrorStatus
 [Summary of function] Obtain AAC decoder error information.
 [Format] call a2d_GetErrorStatus
 [Arguments] None
 [Return value] R0 Error status
 [Function] Return the values below as AAC decoder error information.
 Processing cannot be continued following the occurrence of an error.

Name	Value	Contents
_AAC_EBIT_FATAL_ERROR	0x0001	This is a fatal error.
_AAC_EBIT_CCE_FOUND	0x0002	A CCE ^{Note} was detected and ignored.
_AAC_EBIT_CRC_ERROR	0x0004	A CRC error occurred on ADTS format data.
_AAC_EBIT_NO_HEADER	0x0008	No header was found.

★

Note CCE : Coupling Channel Element

[Registers used] R0
 [Hardware resourcement]
 Maximum stack level 0
 Maximum loop stack level 0
 Maximum number of repeats 0
 Maximum number of cycles 4

2.2.7 aac_dec_fillbits function

The aac_dec_fillbits function is a user function called by μ SAP77016-B08 (callback function). Create the function using the following specifications.

	[Classification]	Input data acquisition function
	[Function name]	aac_dec_fillbits
	[Summary of function]	Fills input buffer with bit stream required for AAC decoding
	[Format]	a2d_Dec calls this function using the format call DP4. Set the address of this function using the a2d_InitDec function.
★	[Arguments]	a2d_Dec sets the following registers and calls the user-defined function. R1 Fill request word count DP0 Input data write pointer DN0 1 DMX Input buffer size (1024 words fixed)
★	[Return value]	R0 Fixed to 0 DP0 Input data write pointer
	[Function]	Fill the input buffer with a bit stream required for AAC decoding.
	[Registers used]	If using registers other than those shown below, use them after saving register contents in memory. ★ • R0, R2, R3

★ 2.2.8 aac_read_1word function

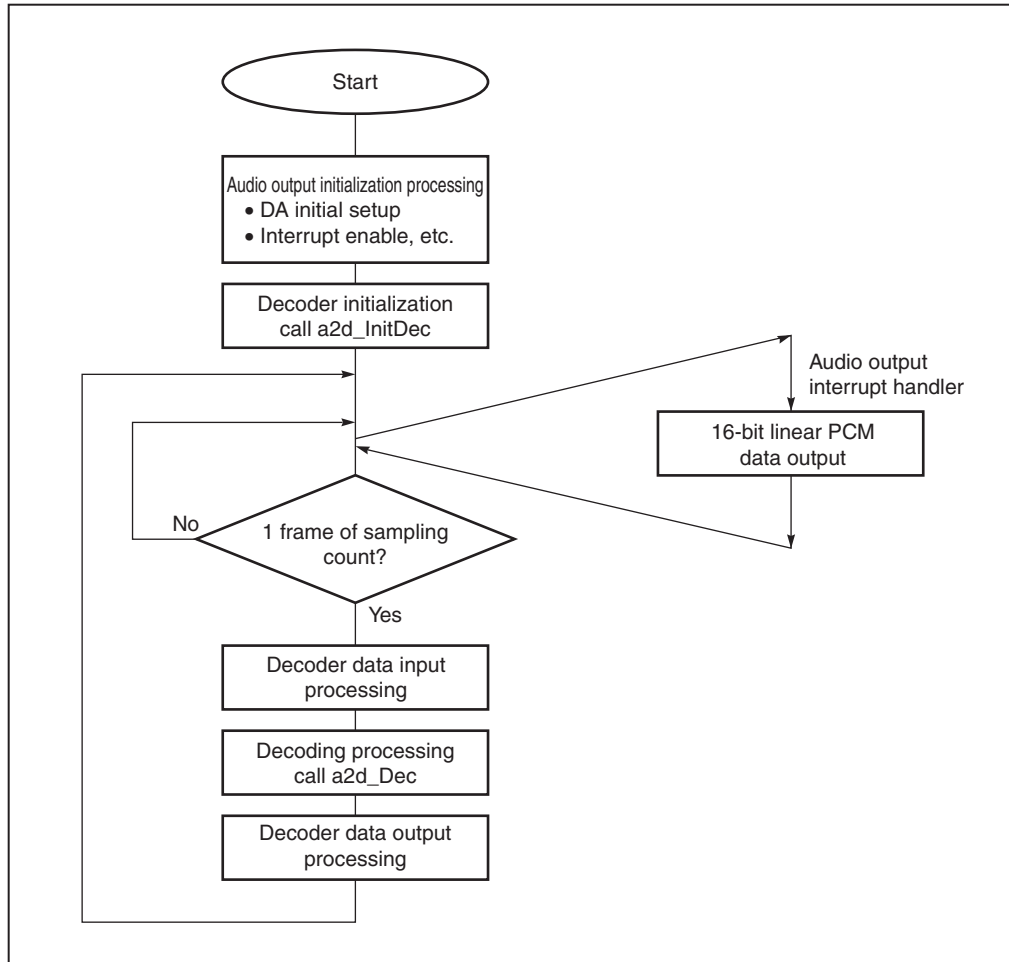
The aac_read_1word function is a user function called by μ SAP77016-B08 (callback function). Create the function using the following specifications.

[Classification]	Header seek function
[Function name]	aac_read_1word
[Summary of function]	Reads a header of the next frame to decode.
[Format]	a2d_Dec calls this function using the format call DP4. Set the address of this function using the a2d_InitDec function.
[Arguments]	a2d_Dec sets the following register and calls the user-defined function. R2 Size of the current frame to seek (byte) R7 Information of frame position 0x000d: The beginning of the frame is higher byte (bit 15 to bit 8) of a word. 0x0005: The beginning of the frame is lower byte (bit 7 to bit 0) of a word. DP1 Input buffer (user-defined) read pointer (This pointer has gone ahead just 6 bytes from the beginning of the current frame.)
[Return value]	R0 a header of the next frame Remark: If R0 is an expected header value (0xfff8 or 0xfff9), - a2d_Dec realize that the header recognition of the current frame is correct. - a2d_Dec output the error code (CRC error) as a return value. If R0 is other value, - a2d_Dec realize that the header recognition of the current frame is error. - a2d_Dec start seeking a header of the frame again.
[Function]	In the case of CRC error in ADTS decoding, a2d_Dec calls this function. This function seeks and reads a header of the next frame to decode by frame size (R2), frame position (R7) and input buffer read pointer (DP1). This header information is used for distinction whether the header recognition of the current frame is correct in a2d_Dec.
[Registers used]	If using registers other than those shown below, use them after saving register contents in memory. • R0, R1, R2, R7, DP1

2.3 Application Processing Flow

Figure 2-3 shows an example of the processing of an application that uses μ SAP77016-B08.

Figure 2-3. Application Processing Flow (Decoder)



The audio data I/O processing section of the interrupt handler is processing that depends on the hardware of the target system. Consequently, the user should design it to suit the target system.

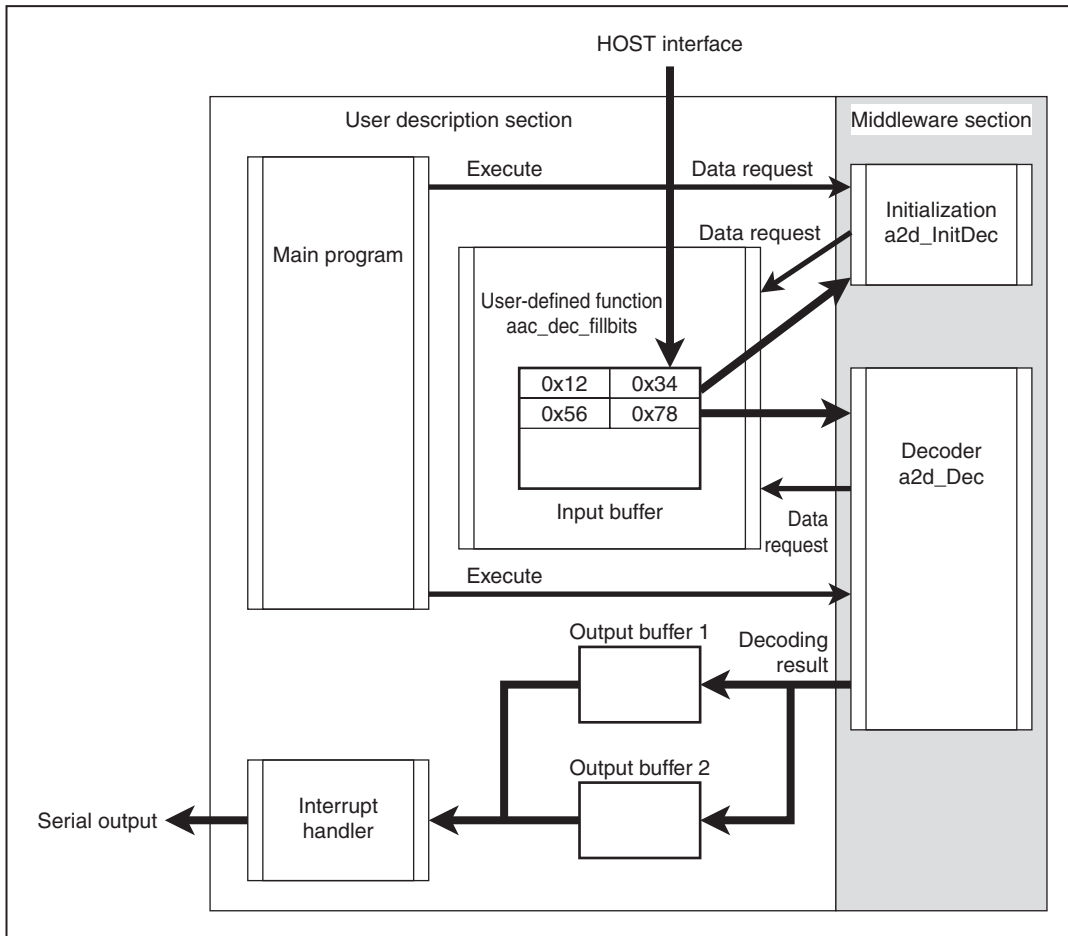
2.4 Data Flow

Figure 2-4 shows an example of the data flow when decoding.

Data in the input buffer must be set in order from MSB to LSB.

For example, place the data 0x1234, 0x5678, ... in the order 0x12, 0x34, 0x56, 0x78,

Figure 2-4. Sample Data Flow



CHAPTER 3 INSTALLATION

3.1 Installation Procedure

The μ SAP77016-B08 (AAC decoder middleware) is supplied on a 3.5-inch floppy disk (1.44 MB). The procedure for installing the μ SAP77016-B08 in the host machine is outlined below.

- (1) Set the floppy disk in the floppy disk drive and copy the files to the directory where WB77016 and HSM77016 (DSP tools) are used (e.g. C:\DSPTools).

The following is an example of when files are copied from the A drive to the C drive.

```
A:\>xcopy /s *.* c:\DSPTools<CR>
```

- (2) Confirm that the files have been copied. Refer to **1.3.5 Directory configuration** for details on the directories.

```
A:\>dir c:\DSPTools<CR>
```

3.2 Sample Program Creation Procedure

A sample program is stored in the smp directory.

The sample program operates on HSM77016 (high-speed simulator) Ver. 2.32 or later. Using the timing files described later makes it possible to simulate data I/O. Refer to **CHAPTER 4 SYSTEM EXAMPLE** regarding timing files.

The following is an explanation of how to build the AAC decoder middleware sample program.

- (1) Start up the WB77016 (workbench) Ver.2.4 or later.
- (2) Open the sample.prj project file.
Example) Specify sample.prj with the Open Project command on the Project menu.
- (3) Execute Build and confirm that sample.lnk has been created.
Example) The sample.lnk file can be created by selecting the Build All command from the Make menu.
- (4) Start up the HSM77016 (high-speed simulator) Ver.2.32 or later.
- (5) Open the sample.lnk file.
Example) Specify sample.lnk with the Open command on the File menu.
- (6) Open timing files (sample.tmg, serclk.tmg, serot16.tmg).
serclk.tmg and serot16.tmg are files provided by HSM77016 in Example.
Example) Specify sample.tmg with the Open command on the File menu.

3.3 Symbol Naming Regulations

The symbols used in this library are named according to the following regulations.

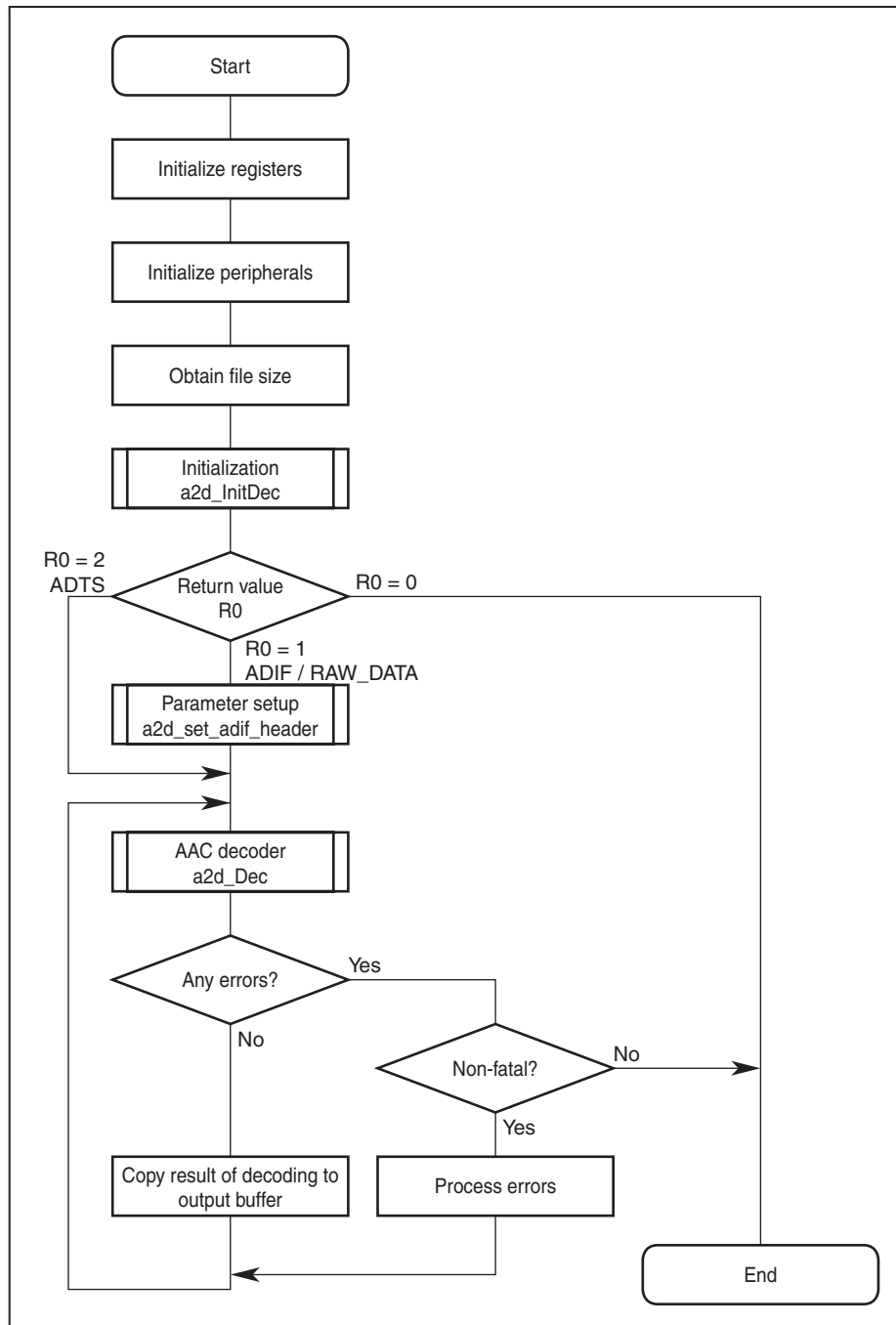
Table 3-1. Symbol Names

Classification	Regulation
Function name, variable name	a2d_xxxx
Macro, constant name	a2d_XXXX
Section name	__A2D_XXXX (Two leading underscores)

3.4 Sample Program Processing Flow

Figure shows the processing of a sample program that uses the AAC decoder.

Figure 3-1. Sample Program Processing Flow



CHAPTER 4 SYSTEM EXAMPLE

4.1 Simulation Environment Using Timing Files

An example in which an audio decoding decompression-processing simulator and timing files are used is shown below. Encoded data is input, and audio data is output frame by frame after each frame has undergone decompression processing.

[Software environment]

- High-speed simulator: HSM77016 Ver. 2.32 or later
- Sample program: sample.lnk (created in **3.2 Sample Program Creation Procedure**)
- Timing file: sample.tmg

4.2 Operation

- <1> Start up the HSM77016 (High-speed simulator)
- <2> Open sample.lnk created in **3.2 Sample Program Creation Procedure**.
Example Specify sample.lnk with Open command on the File menu.
- <3> Open the timing files (sample.tmg, serclk.tmg, serot16.tmg).
serclk.tmg and serot16.tmg are files provided by HSM77016 in Example.
Example Specify sample.tmg with Open command on the File menu.
- <4> Make the wait settings.
Example Set waits to the DWTR/IWTR registers in the setting windows opened by selecting Periphery Register on the Window menu.
- <5> Execute with Run.

(a) Timing file sample.tmg

HSM77016 (high-speed simulator) provides a function for simulating external I/O using a timing file.

(b) Data file input (16-bit data)

Data is input from a file via the host interface. An example of the description format is shown below.

- Preparation

```

local data                ; Compressed data storage variable
local size                ; AAC file size (bytes)

set DEBUG_ID = 1         ; select target
open input "L144100.dat" ; File name of AAC file converted to text data
set size = 65446        ; AAC file size (size of binary file in bytes)

```

- Input processing

(1/2)

```

        set pin hcs = 1                ; terminate any write access, which might
        set pin hwr = 1                ; be active
        set pin hrd = 1                ;

; send AAC file size
        wait cond pin hwe == 0        ; wait till write is allowed
        wait cond pin hcs == 1        ; and no read is in progress
        set pin hcs = 0                ; perform the access...
        set port ha = 0                ; select higher byte of HDT
        set pin hwr = 0                ; start input
        set port hd = (size>>16)&0xFF ; input low byte to host port
        wait 100ns                    ; access duration
        set pin hwr = 1                ; end output
        set pin hcs = 1                ; terminate first access...
        wait 5ns                      ; delay
        set port ha = 1                ; select higher byte of HDT
        wait 5ns                      ; delay
        set pin hcs = 0                ; performe second access...
        set pin hwr = 0                ; start output
        set port hd = (size>>24)&0xFF ; input high byte to host port
        wait 100ns                    ; access duration
        set pin hwr = 1                ; end input
        set pin hcs = 1                ; end access

        wait 1                        ;

        wait cond pin hwe == 0        ; wait till write is allowed
        wait cond pin hcs == 1        ; and no read is in progress
        set pin hcs = 0                ; perform the access...
        set port ha = 0                ; select higher byte of HDT
        set pin hwr = 0                ; start input
        set port hd = (size>>0)&0xFF  ; input low byte to host port
        wait 100ns                    ; access duration
        set pin hcs = 1                ; terminate first access...
        set pin hwr = 1                ; end output
        wait 5ns                      ; delay
        set port ha = 1                ; select higher byte of HDT
        wait 5ns                      ; delay
        set pin hcs = 0                ; performe second access...
        set pin hwr = 0                ; start output
        set port hd = (size>>8)&0xFF  ; input high byte to host port
        wait 100ns                    ; access duration

```

- Input processing

(2/2)

```

        set pin hwr = 1          ; end input
        set pin hcs = 1          ; end access

do
    exit size<=0                ;

    wait cond pin hwe == 0      ; wait till write is allowed
    wait cond pin hcs == 1      ; and no read is in progress
    set pin hcs = 0             ; perform the access...
    set port ha = 0             ; select higher byte of HDT
    set pin hwr = 0             ; start input
    input data                  ; input host data to temp variable
    set port hd = data&0xFF      ; input low byte to host port
    wait 100ns                  ; access duration
    set pin hcs = 1             ; terminate first access...
    set pin hwr = 1             ; end output
    wait 5ns                    ; delay
    set port ha = 1             ; select higher byte of HDT
    wait 5ns                    ; delay
    set pin hwr = 0             ; start output
    set pin hcs = 0             ; performe second access...
    set port hd = (data>>8)&0xFF ; input high byte to host port
    wait 100ns                  ; access duration
    set pin hwr = 1             ; end input
    set pin hcs = 1             ; end access
    set size = size-2           ;

enddo

close input

wait cond (reg ip & 0xffff)==(MAIN.finish & 0xffff)

wait 1

```

- Termination

```

Break                ; Terminate
end

```

APPENDIX SAMPLE PROGRAM SOURCE

- **sample.h**

```
#define __OFFSET      4
#define RAW_DATA_STREAM 0

#define SDT1 0x3800
#define SST1 0x3801
#define SDT2 0x3802
#define SST2 0x3803
#define HDT  0x3806
#define HST  0x3807
#define DWTR 0x3808

extern user_dec_mod
extern user_loaded_size
extern user_decoded_size
extern def_pce_setting
extern user_input_bs
extern user_output_buff1
extern user_output_buff2
extern user_skip_flag
extern user_file_size
extern user_stereo_flag
extern user_frame_odd_flag
extern user_int_output_ptr
extern user_int_sv
extern lib_Scratch_x
extern lib_Scratch_y
```

• sample.asm

(1/3)

★

```

#include "a2d_dec.h"
#include "a2d_err.h"
#include "sample.h"

extrn user_wait
public start_up
extrn aac_read_lword
extrn aac_dec_fillbits

MAIN IMSEG at 0x300

start_up:

    r0l = 0x0401;
    *HST:x = r0l;

    dn0 = 0                ; for simulation
    dmx = 1                ; for simulation

    r0l = 0x8200           ; lsb-first
                           ; continuous I/O mode

    *SST1:x=r0l            ;
    r0l = user_output_buff1 ;
    *user_int_output_ptr:x=r0l ;
    clr(r0)                ;
    *user_frame_odd_flag:x = r0l ;
    r0l = SR                ; enable interrupt
    r0 = r0 & 0x7fdf       ; SO1
    r0 = r0 | 0x0fdf       ; disable other interrupt
    SR = r0l               ;

    clr(r0)                ;
    *SDT1:x=r0l            ; start output interrupt
    *SDT1:x=r0l            ;

    call fitst_data_read    ; read file size

    r1eh = *user_file_size :x ;
    r1l = *user_file_size+1:x ;
    clr(r1)                 ;
    *user_skip_flag:x = r1l ;

#if RAW_DATA_STREAM /* RAW_DATA_DEBUG */
    r4l = aac_read_lword    ;
    r5l = aac_dec_fillbits ;
    r6l = lib_Scratch_x    ;
    r7l = lib_Scratch_y    ;
    clr(r0)                ; initialize only
    dp0 = user_input_bs    ;
    call a2d_InitDec        ;
    *user_dec_mode:x=r0l    ;
    if (r0==0) jmp dec_error_fatal ; initialize failed
    call a2d_GetStatus      ;
    *user_decoded_size:x = r4h ;
    *user_decoded_size+1:x = r4l ;

```

• sample.asm

(2/3)

```

    dp0 = def_pce_setting          ;
    call a2d_set_adif_header      ;
    if(r0==0) jmp dec_error_fatal ; PCE element information invalid
#else
    r4l = aac_read_lword          ;
    r5l = aac_dec_fillbits        ;
    r6l = lib_Scratch_x           ;
    r7l = lib_Scratch_y           ;
    clr(r0)                       ;
    r0l = _A2D_INI_DECODE_HEADER | _A2D_COMPREX_HEADER_SEARCH
                                   ; initialize internal memory and read header

    dp0 = user_input_bs           ;
    call a2d_InitDec              ;
    *user_dec_mode:x=r0l          ;
    if(r0==0) jmp dec_error_fatal ; initialize failed
    call a2d_GetStatus            ;
    *user_decoded_size:x = r4h    ;
    *user_decoded_size+1:x = r4l  ;
#endif

test_loop:
    r1eh = *user_file_size:x      ;
    r1l  = *user_file_size+1:x    ;
    r0eh = *user_decoded_size :x  ;
    r0l  = *user_decoded_size+1:x ;

    r1  = r1-r0                   ;
    r1  = r1-1                    ; all RAW_DATA_BLOCK larger than 1 byte
    if(r1<=0) jmp finish          ;
    call user_wait                ;
    clr(r1)                       ;
    r1l = *user_skip_flag:x        ;
    clr(r0)                       ;
    r0l = *user_dec_mode:x         ;

start_dec:
    call a2d_Dec                  ;
    if(r0==0) jmp dec_error       ; if decoder failed jmp infinit loop
    call a2d_GetStatus            ;
    r1eh = *user_decoded_size :x  ;
    r1l  = *user_decoded_size+1:x ;
    r1  = r1 + r4                 ;
    *user_decoded_size :x = r1h   ;
    *user_decoded_size+1:x = r1l  ;

    if(r3!=0) jmp _start_next_decode ;

_start_next_decode:
    jmp test_loop                 ;

finish:
    nop                           ;
    jmp start_up                  ;

```

• sample.asm

(3/3)

```
dec_error:
    call a2d_GetErrorStatus          ;
    r1 = r0 & _AAC_EBIT_FATAL_ERROR ;
    if(r1!=0) jmp dec_error_fatal   ;
    r1 = r0 & _AAC_EBIT_CRC_ERROR   ;
    if(r1!=0) jmp dec_error_crc     ;
dec_error_fatal:                    ;
    jmp $                            ;
dec_error_crc:                      ;
    nop                               ; this code use only to DEBUG.
dec_error2:                         ;
    jmp $                            ;
dec_error3:                         ;
    jmp $                            ;

fitst_data_read:
    clr(r0)                          ;
    *user_loaded_size+0:x = r0l      ;
    *user_loaded_size+1:x = r0l      ;
    *user_decoded_size :x = r0l      ;
    *user_decoded_size+1:x = r0l     ;
    r0eh= *HDT:x                    ; read __OFFSET information
    r0l = *HDT:x                    ;

; get file size
    *user_file_size :x=r0h           ;
    *user_file_size+1:x=r0l         ;
    ret                             ;

end
```

★

• sam_call.asm

(1/2)

```

#include "a2d_dec.h"
#include "a2d_err.h"
#include "sample.h"

public aac_dec_fillbits;
public aac_read_lword;

__USER_CALLBACK imseg
/*****
function
    aac_read_lword
input
    r2 frame size[byte]
    r7 remain size
    dp1 aac_input_buff read ptr

output
    r0l header data
*****/
aac_read_lword:
    r2 = r2 - 6                ; 6byte already read.
    r7 = r7 srl 3              ; 0x000d then MSB, 0x0005 then Not MSB
    if(r7 != 0) r2 = r2 - 1    ;
    r7 = r2 & 0x0001          ;
    r0 = *user_loaded_size+0:x ;
    r0l = *user_loaded_size+1:x ; already loaded data size
    r1 = *user_decoded_size+0:x ;
    r1l = *user_decoded_size+1:x ; already decoded data size
    r0 -= r1                   ;
    r0 -= r2                   ;
    if(r0 < 0) jmp _not_read   ; lack of data -> jmp _not_read
    r2 = r2 sra 1              ; convert byte to word

    r0l = dp1                  ;
    r0 = r0 + r2               ;
    clr(r1)                    ;
    r1l = user_input_bs        ;
    r1 = r1 + INPUT_BUFSIZE    ;
    r1 = r1 - r0               ;
    if(r1 > 0) jmp _set_ptr    ;
    r0 = r0 - INPUT_BUFSIZE    ;

_set_ptr:
    dp1 = r0l                  ;
    nop                        ;
    r0l = *dp1%%               ;

    if(r7 == 0) ret           ;
    r0 = r0 sll 8              ;
    r2l = *dp1                 ;
    r2 = r2 srl 8              ;

```

• sam_call.asm

(2/2)

```

    r0 = r0 | r2          ;
    ret                   ;

_not_read:
    clr(r0)              ;
    ret                   ;

/*****
function
    aac_dec_fillbits
input
    r1 req size [word]
    dp0 user_input_bs write ptr
    dn0 0x01
    dmx INPUT_BUFSIZE-1
output
    dp0 user_input_bs write ptr
*****/
aac_dec_fillbits:

#if INPUT_BUFSIZE<(12288/16+1)
    Error too small INPUT_BUFSIZE
#endif

    r2 = *user_file_size+0:x      ;
    r2l = *user_file_size+1:x     ; total data size
    r0 = *user_loaded_size+0:x    ;
    r0l = *user_loaded_size+1:x   ; already loaded data size
r2 = r2 - r0                      ;
    if(r2 <= 0) jmp _load_end     ; if all data loaded return
    r2 = r2 + 1                   ;
    r2 = r2 sra 1                 ; conver byte to word
    r3 = r2 - r1                  ;
    if(r3 < 0) r1 = r2           ;

    loop r1l {                    ;
        r0 = *HDT:x              ;
        *dp0%% = r0h             ;
    }

    r0 = *user_loaded_size+0:x    ;
    r0l = *user_loaded_size+1:x   ; already loaded data size
    r1 = r1 sll 1                 ;
    r0 += r1                      ;
    *user_loaded_size+0:x = r0h   ;
    *user_loaded_size+1:x = r0l   ;
_load_end:
    clr(r0)                    ;
    ret                          ;

end

```

•sam_data.asm

(1/2)

★

```

#include "a2d_dec.h"

public user_dec_mode
public user_loaded_size
public user_decoded_size
public user_file_size
public user_skip_flag
public user_stereo_flag

public user_input_bs
public user_output_buff1
public user_output_buff2

public user_frame_odd_flag
public user_int_output_ptr
public user_int_sv

public def_pce_setting

public lib_Scratch_x
public lib_Scratch_y

LIB_SCRATCH_X XRAMSEG AT 0x0000
lib_Scratch_x:      ds      2048
LIB_SCRATCH_Y YRAMSEG ALIGN AT 0
lib_Scratch_y:      ds      4096

MAINX XRAMSEG
user_dec_mode:      ds      1
user_loaded_size:   ds      2
user_decoded_size:  ds      2
user_file_size:     ds      2
user_skip_flag:     ds      1
user_stereo_flag:   ds      1
user_frame_odd_flag: ds     1
user_int_output_ptr: ds     1
user_int_sv:        ds      6

MAINRX XRAMSEG
def_pce_setting:
    DW      0x0441          ; <profile              = LOW COMPLEXITY>
                          ; <sampling frequency = 44100>
                          ; <num_front_channel_elements=1>
    DW      0              ;
    DW      0              ;
                          ;define front channel
    DW      0x0200         ; <front_element_is_cpe[0]   =1>
                          ; <front_element_tag_select[0]=0>
    DS      7              ;
                          ;define side channel
    DS      8              ;
                          ;define back channel
    DS      1              ;lfe
    DS      8              ;
                          ;define assoc

```

• sam_data.asm

(2/2)

```
DS      2      ;
                ;define cce
DS      8      ;
DW      0xffff ;end mark(only for product debugging)

__AAC_DEC_BS_XRAMSEG1 XRAMSEG ALIGN      ;
user_input_bs:      ds      INPUT_BUFSIZE ;

__AAC_SAMPLE_OUTPUT_BUFFX XRAMSEG ALIGN
user_output_buff1: ds      OUTPUT_BUFSIZE ;
;      even L ch      ;
;      odd  R ch      ;

user_output_buff2: ds      OUTPUT_BUFSIZE ;
;      even L ch      ;
;      odd  R ch      ;
end
```

• sam_int.asm

(1/2)

★

```

#include "a2d_dec.h"
#include "a2d_err.h"
#include "sample.h"

extrn start_up
extrn aac_dec_fillbits;
extrn aac_read_lword

MAIN_VECTOR IMSEG at 0x200
    jmp start_up;

org 0x224
    jmp serial_out        ;
    nop                   ;
    nop                   ;

public user_wait

#define _svR0L                (user_int_sv+0)
#define _svR0H                (user_int_sv+1)
#define _svR0E                (user_int_sv+2)
#define _svDP0                (user_int_sv+3)
#define _svDN0                (user_int_sv+4)
#define _svDMX                (user_int_sv+5)

serial_out:
    *_svR0L:x = r0l        ;
    *_svR0H:x = r0h        ;
    *_svR0E:x = r0e        ;
    r0l = dp0              ;
    *_svDP0:x = r0l        ;
    r0l = dn0              ;
    *_svDN0:x = r0l        ;
    r0l = dmx              ;
    *_svDMX:x = r0l        ;

    r0l = *user_int_output_ptr:x    ;
    dp0 = r0l                        ;
    dn0 = 0x01                        ;
    dmx = 1024*4-1                    ;

    r0l = *dp0%%                        ; get left PCM
    *SDT1:x = r0l                        ;

    r0l = dp0                            ;
    *user_int_output_ptr:x=r0l            ;

    r0l = *_svDMX:x                        ;
    dmx = r0l                              ;
    r0l = *_svDN0:x                        ;
    dn0 = r0l                              ;
    r0l = *_svDP0:x                        ;
    dp0 = r0l                              ;
    r0e = *_svR0E:x                        ;
    r0h = *_svR0H:x                        ;

```

• sam_int.asm

(2/2)

```
    r0l = *_svR0L:x          ;
    reti                      ;

user_wait:
    clr(r0)                  ;
    clr(r1)                  ;
    r1l = *user_frame_odd_flag:x ;
    r1 = r1 ^ 0x01          ;
    *user_frame_odd_flag:x = r1l ;
    if(r1==0) jmp _wait_frame_odd ;

_wait_frame_even:
    clr(r0)                  ;
;    halt                    ;
    r0l = *user_int_output_ptr:x ;
    r0 = r0 - user_output_buff2 ;
    if (r0 < 0 ) jmp _wait_frame_even ;
    dp0 = user_output_buff1 ;
    jmp _wait_frame_end ;

_wait_frame_odd:
    clr(r0)                  ;
;    halt                    ;
    r0l = *user_int_output_ptr:x ;
    r0 = r0 - user_output_buff2 ;
    if (r0 > 0 ) jmp _wait_frame_odd ;
    dp0 = user_output_buff2 ;
;    jmp _wait_frame_end ;

_wait_frame_end:
    ret                      ;
;

end
```

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